Part Number: XZCBDMDKDG62W-2

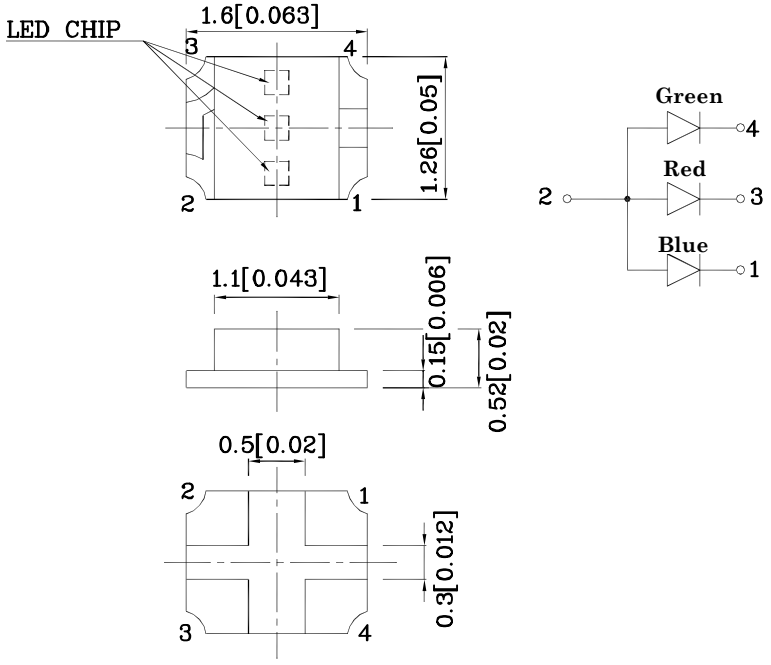
1.6X1.26mm SMD CHIP LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- RoHS compliant

ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Package Schematics



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.2(0.008") unless otherwise noted.
3. Specifications are subject to change without notice.

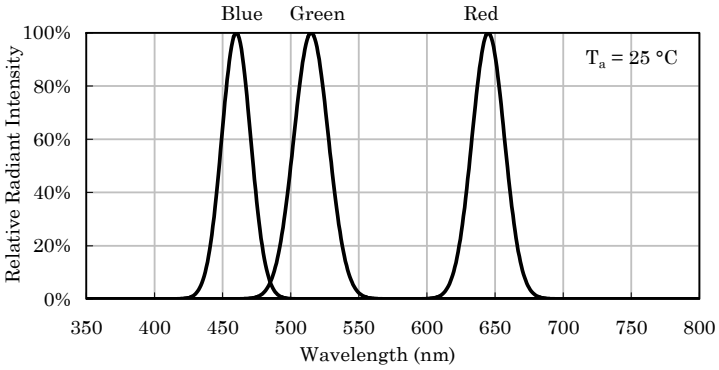
Absolute Maximum Ratings (T_A=25°C)		**Blue (InGaN)**	**Red (AlGaInP)**	**Green (InGaN)**	**Unit**
Reverse Voltage	V_R	5	5	5	V
Forward Current	I_F	30	30	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	150	185	150	mA
Power Dissipation	P_D	120	75	102.5	mW
Electrostatic Discharge Threshold (HBM)		250	3000	450	V
Operating Temperature	T_A	-40 ~ +85			°C
Storage Temperature	Tstg				
Thermal resistance (Junction/ambient)	$R_{th\ j\text{-}a}$	490	300	380	°C/W

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

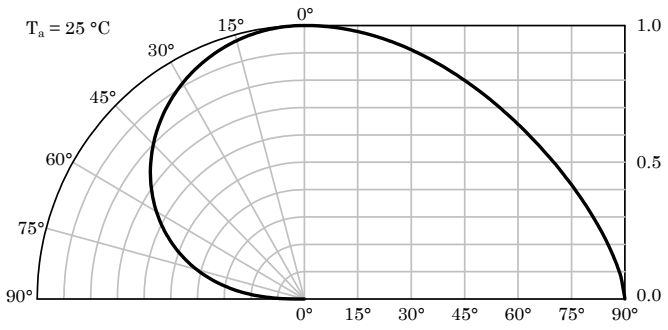
Operating Characteristics (T_A=25°C)		**Blue (InGaN)**	**Red (AlGaInP)**	**Green (InGaN)**	**Unit**
Forward Voltage (Typ.) (I_F=20mA)	V_F	3.3	1.95	3.3	V
Forward Voltage (Max.) (I_F=20mA)	V_F	4	2.5	4.1	V
Reverse Current (Max.) (V_R=5V)	I_R	50	10	50	μA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I_F=20mA)	λP	460*	645*	515*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I_F=20mA)	λD	465*	630*	525*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I_F=20mA)	△λ	25	28	30	nm
Capacitance (Typ.) (V_F=0V, f=1MHz)	C	100	35	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I_F=20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 2θ 1/2
				min.	typ.		
XZCBDMDKDG62W-2	Blue	InGaN	Water Clear	40 40*	69 69*	460*	140°
	Red	AlGaInP		120 40*	198 79*	645*	
	Green	InGaN		400 400*	597 597*	515*	

*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

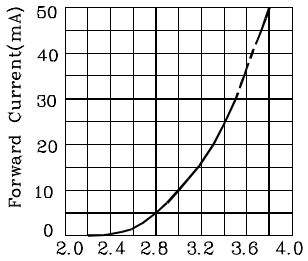


Relative Intensity Vs. CIE Wavelength

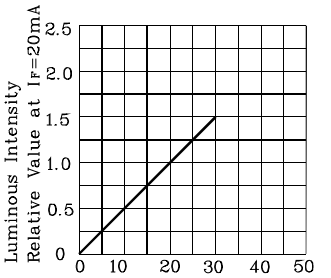


Spatial Distribution

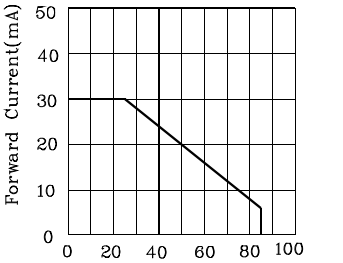
❖ Blue



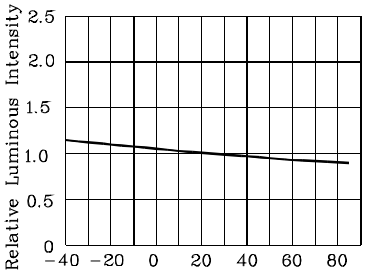
FORWARD CURRENT Vs.
FORWARD VOLTAGE



LUMINOUS INTENSITY Vs.
FORWARD CURRENT

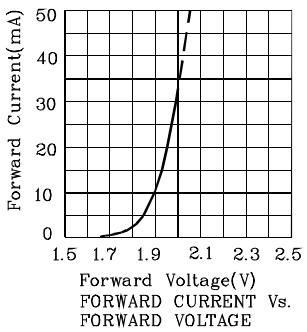


FORWARD CURRENT
DERATING CURVE

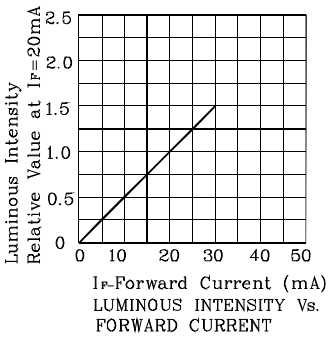


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

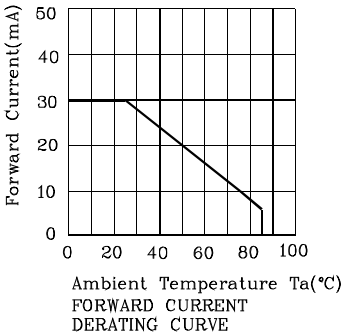
❖ Red



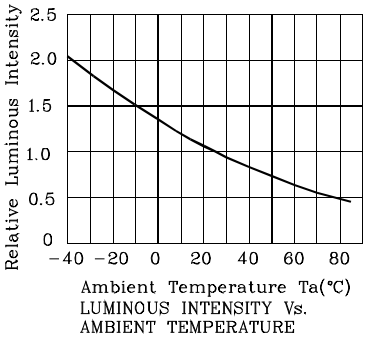
FORWARD CURRENT Vs.
FORWARD VOLTAGE



LUMINOUS INTENSITY Vs.
FORWARD CURRENT

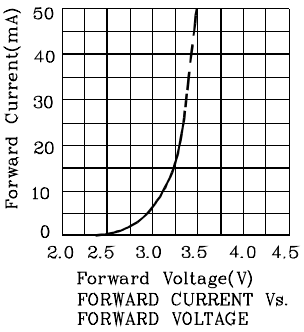


FORWARD CURRENT
DERATING CURVE

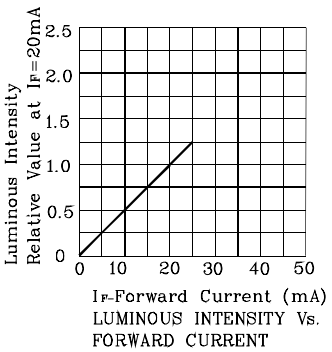


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

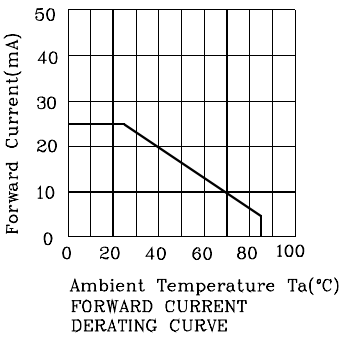
❖ Green



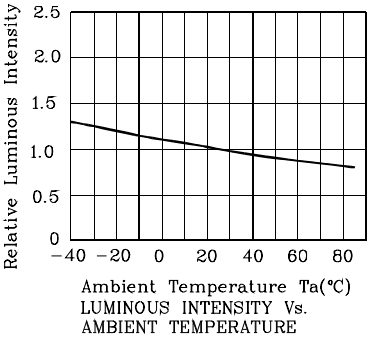
FORWARD CURRENT Vs.
FORWARD VOLTAGE



LUMINOUS INTENSITY Vs.
FORWARD CURRENT

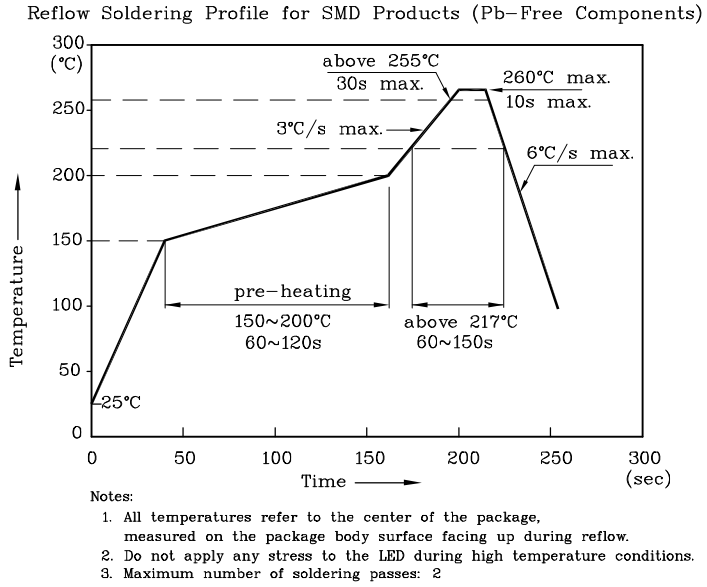


FORWARD CURRENT
DERATING CURVE

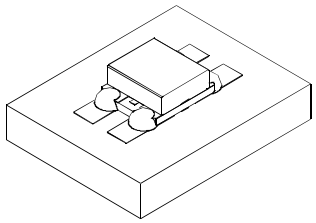


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

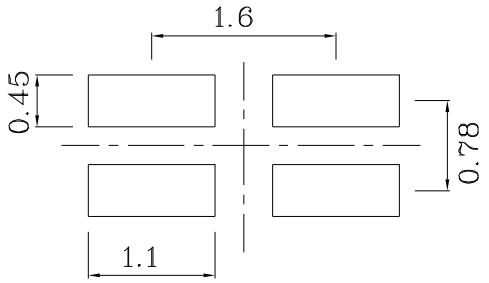
LED is recommended for reflow soldering and soldering profile is shown below.



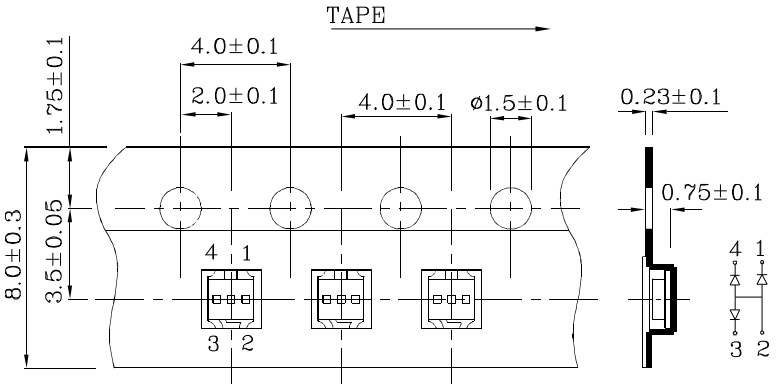
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



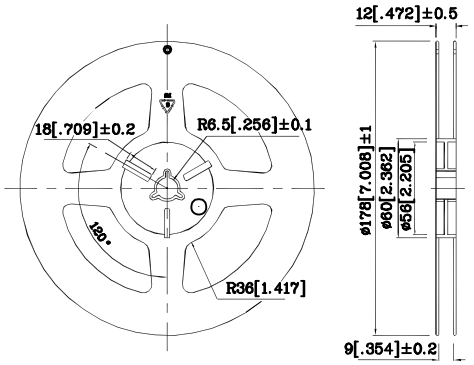
❖ Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



❖ Tape Specification (Units : mm)



❖ Reel Dimension



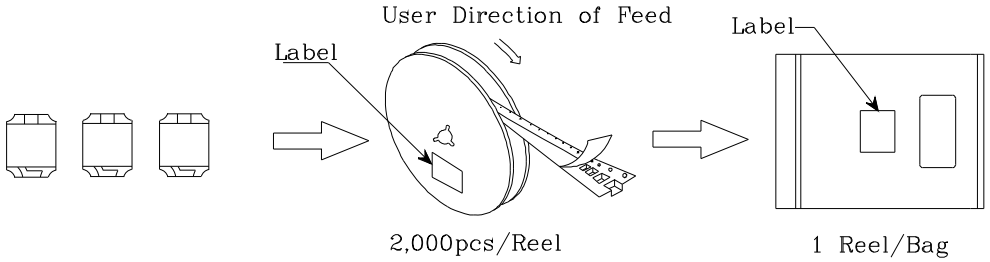
Remarks:

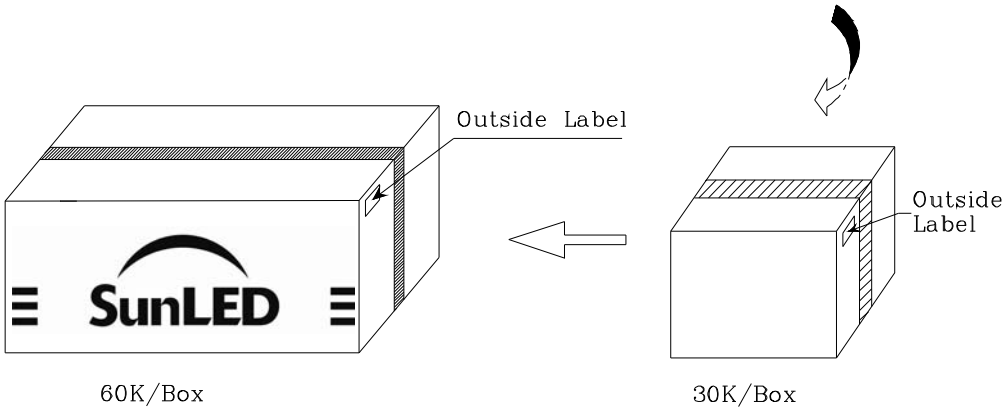
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

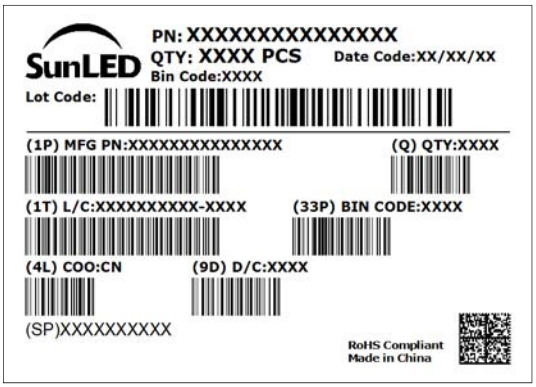
1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS







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